

General Description

The 5950A uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications.

Features

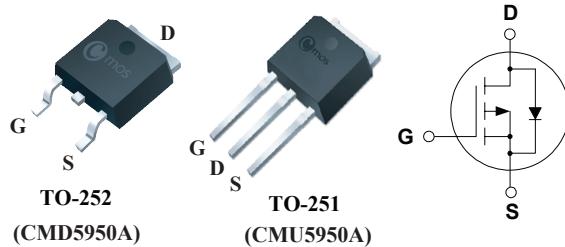
- P-Channel
- Low ON-resistance.
- Fast Switching
- 100% avalanche tested

Absolute Maximum Ratings**Product Summary**

BVDSS	RDSON	ID
-100V	45mΩ	-33A

Applications

- Inverters
- Motor drive
- DC / DC converter

TO-252/251 Pin Configuration

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-100	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_c = 25^\circ C$	Continuous Drain Current	-33	A
I_{DM}	Pulsed Drain Current	-105	A
EAS	Single Pulse Avalanche Energy	220	mJ
$P_D @ T_c = 25^\circ C$	Total Power Dissipation	50	W
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	62.5	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-case	---	2	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=-250\mu\text{A}$	-100	---	---	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=-10\text{V}$, $I_D=-20\text{A}$	---	40	45	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_D=-8\text{A}$	---	45	50	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	-2	---	-4	V
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=-100\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	-1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$, $I_D=-10\text{A}$	---	20	---	S
Q_g	Total Gate Charge	$I_D=-20\text{A}$	---	75	---	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=-50\text{V}$	---	15	---	
Q_{gd}	Gate-Drain Charge	$V_{\text{GS}}=-10\text{V}$	---	16	---	
$T_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DS}}=-50\text{V}$	---	25	---	ns
T_r	Rise Time	$I_D=-10\text{A}$	---	95	---	
$T_{\text{d(off)}}$	Turn-Off Delay Time	$R_L=5.6\Omega$	---	310	---	
T_f	Fall Time	$V_{\text{GS}}=-10\text{V}$	---	100	---	
C_{iss}	Input Capacitance	$V_{\text{DS}}=-20\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	6600	---	pF
C_{oss}	Output Capacitance		---	270	---	
C_{rss}	Reverse Transfer Capacitance		---	200	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t_{rr}	Reverse Recovery Time	$I_S=-8\text{A}$ $dI/dt=-100\text{A}/\mu\text{s}$	---	60	---	ns
Q_{rr}	Reverse Recovery Charge		---	150	---	nC
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_S=-10\text{A}$	---	---	-1.2	V

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